















ESD

TVS

MOS

LDO

Diode

Sensor

DC-DC

Product Specification

Domestic Part Number	FDN340P
Overseas Part Number	FDN340P-EV
▶ Equivalent Part Number	FDN340P





SOT-23 Plastic-Encapsulate MOSFETS

FDN340P

P-Channel 20-V(D-S) MOSFET

V(BR)DSS	RDS(on)MAX	ID
	70mΩ@ -4.5V	(1)
-20 V	110mΩ@ -2.5V	-2A
	210mΩ@ -1.8V	

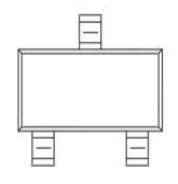
FEATURE

- TrenchFET Power MOSFET
- Supper high density cell design

APPLICATION

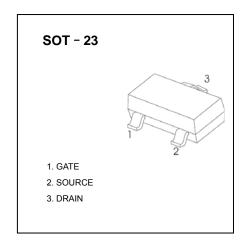
- Battery protection
- Load switch
- **%** Battery management

MARKING



Equivalent Circuit





Maximum ratings (Ta=25[°]C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	-20	V
Gate-Source Voltage	VGS	±8	V
Continuous Drain Current	ID	-2	_
Pulsed Diode Curren	IDM	-10	А
Power Dissipation	PD	1.1	W
Thermal Resistance from Junction to Ambient (t≤10s)	RθJA	250	°C/W
Operating Junction	TJ	150	$^{\circ}$
Storage Temperature	TSTG	-55~+150	$^{\circ}\!\mathbb{C}$



SOT-23 Plastic-Encapsulate MOSFETS

MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics (Ta = 25 $^{\circ}$ C Unless Otherwise Noted)

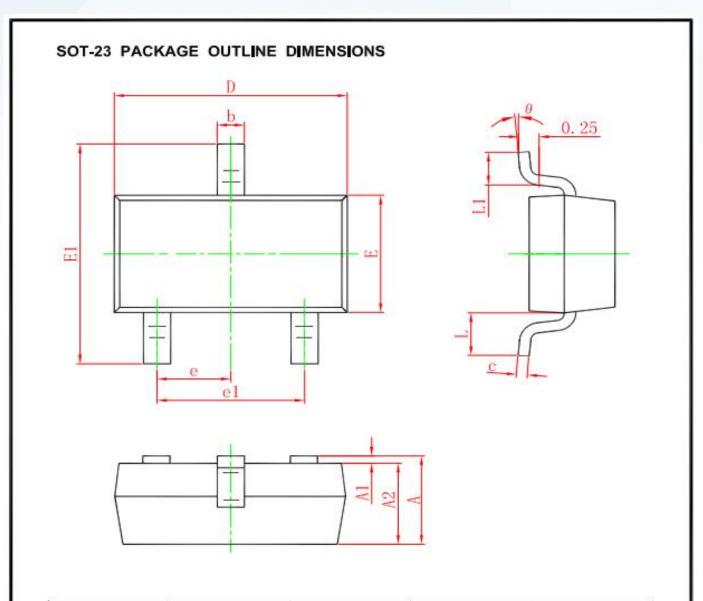
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static		l.				
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = -250μA	-20			V
Gate-source threshold voltage	VGS(th)	VDS =VGS, ID = -250μA	-0.4		-1.5	V
Gate-source leakage	IGSS	VDS =0V, VGS = ±8V			±100	nA
Zero gate voltage drain current	IDSS	VDS = -16V, VGS =0V			-1	μA
		VGS = -4.5V, ID = -2A		52	70	mΩ
Drain-source on-state resistancea	RDS(on)	VGS = -2.5V, ID = -1.7A		78	110	mΩ
		VGS = -1.8V, ID = -1.2A			210	mΩ
Forward transconductancea	gfs	VDS = -4.5V, ID = -2A		8		S
Diode forward voltage	VSD	IS= -1A,VGS=0V		-0.8	-1.2	V
Dynamic	-!	!		!	!	
Input capacitance	Ciss			600		pF
Output capacitance	Coss	VDS = -10V,VGS =0V, f=1MHz		175		pF
Reverse transfer capacitanceb	Crss			80		pF
Total gate charge	Qg			8		nC
Gate-source charge	Qgs	VDS = -10V,VGS = -4.5V, ID = -2A		1.3		nC
Gate-drain charge	Qgd			2.2		nC
Gate resistance	Rg	f=1MHz	0.5		3.2	Ω
Switchingbtr				1	Į.	
Turn-on delay time	td(on)			6		ns
Rise time	tr	VDS= -10V		9		ns
Turn-off delay time	td(off)	RL=3.5Ω, ID ≈ -1A, VGEN= -4.5V,Rg=3Ω		31		ns
Fall time	tf			26		ns
Drain-source body diode cha	racteristics	str				
Continuous Source-Drain Diode Current	IS	Tc=25℃			-1.2	Α
Pulsed Diode forward Curren	ISM				-10	Α

Note:

- 1. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t < 10 sec.
- 3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production testing.



SOT-23 Plastic-Encapsulate MOSFETS



Complete	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950	TYP.	0.037 TYP.		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF.		0.022	REF.	
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	



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